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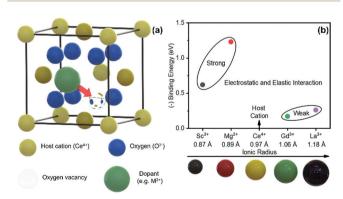
# Electromechanical dopant-defect interaction in acceptor-doped ceria<sup>†</sup>

Ahsanul Kabir, <sup>(D)</sup>\*<sup>a</sup> Victor Buratto Tinti,<sup>a</sup> Maxim Varenik,<sup>b</sup> Igor Lubomirsky <sup>(D)</sup><sup>b</sup> and Vincenzo Esposito <sup>(D)</sup>\*<sup>a</sup>

Oxygen defective cerium oxide  $CeO_{2-\delta}$  exhibits a non-classical giant electromechanical response that is superior to that of leadbased electrostrictors. In this work, we report the key-role of acceptor dopants, with different size and valence  $(Mg^{2+}, Sc^{3+}, Gd^{3+}, and La^{3+})$ , on polycrystalline bulk ceria. Different dopants tune the electrostrictive properties by changing the electrosteric dopant–defect interactions. We find two distinct electromechanical behaviors: when the interaction is weak (dopant-vacancy bind-ing energy  $\leq 0.3 \text{ eV}$ ), electrostriction displays a high coefficient  $(M_{33})$ , up to  $10^{-17} \text{ (m V}^{-1})^2$ , with strongly time-dependent effects. In contrast, we observe no time-dependent effects when the inter-action becomes strong ( $\geq 0.6 \text{ eV}$ ).

Over the last four decades, oxygen defective ceria has been widely used in multiscale applications from electrochemical devices to automotive catalysts, gas sensors, etc.<sup>1-3</sup> Furthermore, a recent discovery demonstrated that ceria thin films display an unconventional electromechanical strain at room temperature.<sup>4-7</sup> For example, the reported electrostriction coefficient  $(M_e)$  is around  $6.5 \times 10^{-18} \text{ (m V}^{-1})^2$  for  $[V_0^{\bullet\bullet}] = 5\%$ , *i.e.* 20 mol% Gd-doped ceria (GDC).<sup>4</sup> Such a value is extremely high for a material with low dielectric constant  $(\varepsilon_r^{GDC} \approx 30)^8$ and high elastic modulus ( $Y^{GDC} \approx 200$  MPa).<sup>9</sup> Surprisingly, in contrast to conventional inorganic ceramic materials, ceria thin films expand perpendicularly to the applied field direction. These properties are also investigated in bulk ceria and other oxygen defective fluorites ( $Bi_2O_{3-\delta}$ ), illustrating similar outcomes.<sup>10-15</sup> The atomistic origin of this uncommon behavior is associated with the presence of charge compensating oxygen vacancies  $(V_0^{\bullet\bullet})$  in the ceria lattice.<sup>16,17</sup> The  $V_0^{\bullet\bullet}$  creates an electroactive elastic dipole ( $Ce_{Ce}-V_{O}^{\bullet\bullet}$ ) having a long bond

length and six anomalous reduced ( $Ce_{Ce}-O_{O}$ ) bonds when compared to the bond length of undoped ceria, leading to the development asymmetric charge distribution and anisotropic local dipolar elastic field around the host lattice.<sup>18</sup> Upon interaction with an electric field, this distorted fluorite lattice  $(Ce_{Ce}O_O - V_O^{\bullet \bullet})$  complex becomes a more ideal-like fluorite structure and successively induces a considerable local strain and vice versa.<sup>16,17</sup> Although governed by the  $Ce_{Ce} - V_{O}^{\bullet \bullet}$ complex, the local configuration of an oxygen vacancy is a crucial feature controlling electrostriction in bulk ceria.<sup>16,19</sup> Literature reports of both computational and experimental studies demonstrate that the configuration of oxygen vacancies in the lattice strongly depends on dopant size and valence, *i.e.*, electrostatic (attractive) and elastic (repulsive) interaction between the cation and vacancy.<sup>20-22</sup> Fig. 1a schematically represents a simple configuration of dopant cations concerning nearby oxygen vacancies in a unit cell of ceria. In general, the acceptor dopant prefers to occupy the next neighbour (1nn) or next-nearest neighbour (2nn) lattice site of an oxygen vacancy. The electrostatic interaction favors the 1nn site while elastic



**Fig. 1** (a) Schamatic illustration of a unit cell of fluorite structured ceria, showing electrosteric interaction between the acceptor dopant and charge compensating oxygen vacancy. (b) Computationally calculated binding energy (1nn) values of variously doped ceria as a function of dopant radius. The data are taken from V. Butler *et al.*<sup>24</sup>

<sup>&</sup>lt;sup>a</sup> Department of Energy Conversion and Storage, Technical University of Denmark, Kgs, Lyngby 2800, Denmark. E-mail: ahsk@dtu.dk, vies@dtu.dk

<sup>&</sup>lt;sup>b</sup> Department of Materials and Interfaces, Weizmann Institute of Science,

Rehovot 761001, Israel

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relaxation favors 2nn positions. When the total (electrosteric) dopant–defect interaction is significantly high, the dopant tends to cluster with  $V_O^{\bullet\bullet}$ , successively forming small/large scale defect associations and/or segregates locally at the crystalline disorders. The defect associate acts as an electric dipole, in which the binding energy of defect association dominates the ionic conductivity and dielectric constant since it traps more oxygen vacancies.<sup>23</sup>

In this work, we intended to experimentally investigate the effect of dopant type, *i.e.*, total dopant–defect interaction, on the electro-chemo-mechanical properties in bulk ceria. Four different dopants ( $M^n$ ), including Sc<sup>3+</sup>, Mg<sup>2+</sup>, Gd<sup>3+</sup>, and La<sup>3+</sup>, were selected for this purpose. The computational calculations in Fig. 1b estimate that these dopants have a large span in the binding energy (1nn) values covering both strong and weak dopant–vacancy interactions, *e.g.*, 0.15–1.25 eV.<sup>24</sup> As can be seen, the binding energy of dopant defect interaction highly depends on the dopant type. For example, the Sc-and Mg-doped system introduces a stronger interaction than that of Gd-and La-doped ceria. Finally, we correlate the electrostriction behavior with the electrochemical properties from low to intermediate temperatures.

Nanoscale ceria powders with a composition of  $Ce_{1-x}M_xO_{2-\delta}$ where x = 0.10 and 0.05 for trivalent (M = Sc<sup>3+</sup>, Gd<sup>3+</sup>, La<sup>3+</sup>) and divalent ( $M = Mg^{2+}$ ) dopant, respectively were prepared using a combination of co-precipitation and nitrate route.<sup>25</sup> At first, the appropriate amount of metal nitrate salts was dissolved in boiling nitric acid (5 N) under mild stirring and slowly cooled. Then pure ceria  $(CeO_2)$  powder, as synthesized by the coprecipitation method described in 16 was dispersed in ethanol. Sequentially, a metal nitrate solution was transferred into the suspension. After that, the chemically modified suspension was ball-milled with zirconia balls (2 mm diameter) for 10 hours at 50 rpm, oven-dried at 100 °C, and finally calcined at 500 °C for 2 hours. Next, the powder was softly crushed with an agate mortar and pestle and sieved using a 150 µm mesh. For the pellet preparation, the powders were uniaxially cold-pressed (12 mm diameter) under a pressure of 200 MPa for half a minute and sintered at 1450 °C for 10 hours in atmospheric air. The apparent density of the resultant pellet was measured by the Archimedes method in the water medium. The crystallographic phase and microstructure were characterized by X-ray powder diffraction (XRD, Bruker D8) and scanning electron microscopy (SEM, Zeiss Merlin), respectively. For the dielectric and electrochemical measurements, silver paste (electrode) was brushed onto the parallel face of the sample and dried at 600 °C. The electrochemical experiments were performed using the two probe method with a frequency response analyzer (FRA-EIS, Solartron 1260) at 250-450 °C in a frequency range from 1 Hz to 10 MHz in the air with an alternating potential of 100 mV. The room temperature impedance (dielectric) measurement was carried out with a dielectric analyzer (Novocontrol) in a high voltage mode (10 VAC) with frequencies between 1 MHz and 1 mHz. The electromechanical strain was estimated at room temperature under ambient conditions (relative humidity 25-50%) with a proximity sensor of the capacitive type with lock-in detection, as explained in detail elsewhere.<sup>10</sup> The sensitivity of the sensor is 1.9 mV nm<sup>-1</sup> displacement. The longitudinal strain was estimated as the ratio between the displacement of a pushrod connected to the sample surface by a spring and the real thickness of the sample. The setup was calibrated with a commercial sample of PMN-PT (TRS Technologies,  $M_{33} = 3.5 \pm 0.5 \times 10^{-16} \text{ (m V}^{-1})^2$  and a piezoelectric 100-cut quartz single crystal  $d_{33} = 2.3 \pm 0.2 \text{ pm V}^{-1}$ ). The samples were polished (up to 4000 mesh), washed with ethanol/acetone, and then thermally treated at 500 °C for 5 hours in the air. Two mechanically contacted metal electrodes made of stainless steel metal plates were used.

As measured, the sintered pellets are highly dense and above 95% of the theoretical density, agreeing with the microstructural analysis (Fig. S1, ESI<sup>+</sup>). The grains are thermodynamically relaxed and have an average size between 3 and 5 µm, regardless of the composition. The XRD pattern of the samples corresponds with the reference profile of pure ceria (Fig. S2, ESI<sup>†</sup>), illustrating a single-phase cubic fluorite structure without any additional phases. The dielectric constant of a material has a significant role in controlling electrical properties, *i.e.*, dopant-defect interaction and defect cluster.<sup>26</sup> The distinction of the dielectric constant  $(\varepsilon')$  concerning applied frequency is estimated from the imaginary part (Z'') of the complex EIS spectra and represented in Fig. 2a at room temperature. As can be seen,  $\varepsilon'$  is relatively constant from high to intermediate frequencies (up to  $\sim 10$  kHz) for all samples. However,  $\varepsilon'$  increases significantly at lower frequencies, which is associated with increased capacitive effect, leading to accumulation of charge at the high-energy barrier site.<sup>27</sup> As estimated, the GDC and LDC samples have a lower  $\varepsilon'$  value than those of SDC and MDC compounds (see Table 1), indicating that electrostatic interaction between dopant and defect is small in the former. Characteristically, the dielectric constant increases with increasing temperature (Fig. S3, ESI<sup>+</sup>), since the polarization of charge carriers increases at higher temperatures. From the EIS spectra, the electrical conductivity of the sample is measured using the Nyquist formalism,<sup>2</sup> which allows separation of the grain, grain boundary, and electrode

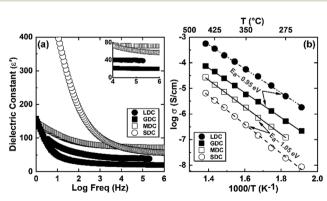


Fig. 2 (a) Estimation of dielectric constant with respect to frequency, measured *via* EIS at room temperature under AC bias of 10 V. (b) The temperature-dependent Arrhenius plot for the total electrical conductivity of variously doped ceria samples, examined in air.

 Table 1
 The estimated dielectric constant, relaxation frequency, and electrostriction coefficient of the samples at room temperature

Sample ID	$f_{\mathrm{g.b.}}\left(\mathrm{Hz}\right)$	$\epsilon'$	$M_{33}$ (1 Hz) (m V <sup>-1</sup> ) <sup>2</sup>	$M_{33}$ (100 Hz) (m V <sup>-1</sup> ) <sup>2</sup>
LDC GDC MDC SDC	$egin{array}{c} 2.0 imes10^1\ 1.0 imes10^1 \end{array}$	25 75	$\begin{array}{c} 0.5 \times 10^{-17} \\ 3.0 \times 10^{-17} \\ 0.4 \times 10^{-17} \\ 0.12 \times 10^{-17} \end{array}$	$\begin{array}{c} 0.04 \times 10^{-17} \\ 0.15 \times 10^{-17} \\ 0.25 \times 10^{-17} \\ 0.15 \times 10^{-17} \end{array}$

contribution (Fig. S4 and S5, ESI†). The resistivity of all compounds is strongly dominated by the grain boundary and they have an ion-blocking factor above 0.9 at 300 °C. The effect of the ion blocking property is qualitatively estimated by the parameter called grain boundary blocking factor ( $\alpha_{g.b.}$ ), where

 $\alpha_{\text{g.b.}} = \frac{R_{\text{g.b.}}}{R_{\text{bulk}} + R_{\text{g.b.}}}$ .<sup>19</sup> In cerium based oxides, not only grain

boundary but also dopant-defect association, nanoclusters, dopant segregation, and residual pores all combined introduce the ion-blocking effect.<sup>2,28</sup> The temperature-dependent total electrical conductivity ( $\sigma$ ) is illustrated in Fig. 2b that follows the Arrhenius expression:

$$\sigma = \sigma_0 \exp\left(-\frac{E_a}{kT}\right) \tag{1}$$

where  $\sigma_0$  is the pre-exponent factor and  $E_a$  the activation energy. Even though all samples contain equivalent oxygen vacancy concentration, the conductivity value differs significantly between the materials. The magnitude of conductivity increases with temperature showing a maximum for LDC and minimum for the SDC sample. Such outcomes simply emphasize the leading contribution of the oxygen vacancy configuration, *i.e.*, dielectric constant, dopant-defect interaction, and defect cluster on tuning the charge migration properties. We attribute the lowest conductivity value in SDC to its limited solubility in ceria, which is close to 3%.<sup>29</sup> Above the solubility level, it is highly expected that Sc3+ forms short- or long-range nanodomains in the lattice and/or grain boundaries. According to Nowick et al., the Sc<sup>3+</sup> dopant also acts as a scavenger for oxygen vacancies in cerium oxide.<sup>29</sup> Interestingly, the activation energy value is equivalent (~1.0 eV) in all samples, emphasizing that the mobility of oxygen vacancies is considerably different in each sample due to different dopant associated traps for vacancies.

The electrostrictive strain of the samples, with a response to the applied electric field, is illustrated in Fig. 3. As noticed, the strain starts to saturate at a particular electric field value, *e.g.*,  $\sim 4-5$  kV cm<sup>-1</sup>, for the LDC and GDC samples. The saturation of strain is fitted with the empirical equation:<sup>10</sup>

$$u(E^2) = M_{33} \cdot E_{\text{sat}}^2 \left[ 1 - \exp\left(-\frac{E^2}{E_{\text{sat}}^2}\right) \right]$$
(2)

here,  $M_{33}$  is the electrostriction strain coefficient, and  $E_{\text{sat}}$  is the saturation electric field. Above the saturation point, a further electrostrictive strain is no longer possible, since the elastic dipole comes to be fully aligned with the high electric field.<sup>15</sup> Besides, at high frequencies, the strain value reduced significantly

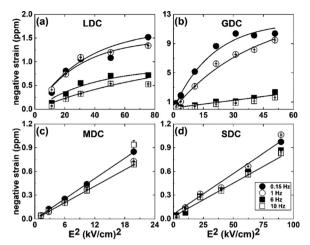


Fig. 3 (a-d) The negative electromechanical strain as a function of electric field square under applied frequencies from  $\sim 0.15$  to 10 Hz.

but followed the typical linear relation.<sup>30</sup> On the other hand, neither strain saturation nor reduction was noticed for the SDC and MDC compounds. The electrostrictive strain coefficient  $(M_{33})$  as a function of applied frequency is reported in Fig. 4a. As observed, the GDC illustrates maximum  $M_{33}$  value having one order higher magnitude in the low frequencies ( $\leq 2$  Hz). At the low-frequency regime, for instance, below 10 Hz, the value of  $M_{33}$  for the GDC and LDC compound is strongly dependent on an applied frequency value. The  $M_{33}$  empirically follows a frequency-associated relaxation, given by:<sup>10</sup>

$$M_{33}(f) = \frac{M_{33}^0}{\sqrt{1 + (\tau f)^{2+\alpha}}} + M_{33}^\infty$$
(3)

where  $M_{33}^0$  and  $M_{33}^\infty$  are the electrostriction coefficient value at low and high frequencies, respectively.  $\tau$  is the characteristic relaxation time, and  $\alpha$  is the non-ideality factor. The fitting parameters are illustrated in Table S1 (ESI†). Surprisingly,  $M_{33}$ does not obey such relation for the SDC and MDC samples. These materials display a frequency-independent steady  $M_{33}$ value of about ~0.1–0.3 × 10<sup>-17</sup> (m V<sup>-1</sup>)<sup>2</sup>. At a high-frequency region, *e.g.*, above 10 Hz, the GDC exhibits a similar  $M_{33}$  value to the former, while LDC displays an order smaller  $M_{33}$  of roughly 0.03 × 10<sup>-17</sup> (m V<sup>-1</sup>)<sup>2</sup> (see Fig. 4b). Finally, the  $M_{33}$ value in the order of  $\geq 0.1 \times 10^{-17}$  (m V<sup>-1</sup>)<sup>2</sup> is still one order of magnitude larger than the classical Newnham empirical law

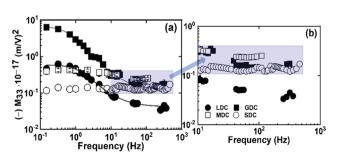


Fig. 4 Frequency-dependent electrostrictive strain coefficient ( $M_{33}$ ) of all samples at (a) 0.15–700 Hz and (b) high-frequency regime.

suggesting that SDC and MDC compounds can be used for prospective frequency insensitive electrostriction applications. Table 1 demonstrates the comparative analysis of the dielectric constant, relaxation frequency, and electrostriction coefficient between the investigated samples.

In this work, variously doped ceria compounds having equivalent oxygen vacancy concentration were fabricated by conventional sintering at higher temperatures. The resultant dense pellets illustrate relaxed grains of micron size. As expected, the samples show a highly deviated dielectric relaxation and total electrical conductivity based on the local configuration of oxygen vacancies built in the materials. Moreover, all of these compounds demonstrate an unconventional electrostriction response. Interestingly, the sample having weak dopant-defect interaction in the lattice generates a frequency-dependent electrostriction behavior. Whereas, the material with strong dopant-defect interaction exhibits a frequency-independent steady electrostriction coefficient from low to high frequencies. To sum up, the local oxygen vacancy configuration and its association with the dopant cation is a crucial factor controlling the electromechanical response in cerium-based compounds.

## Conflicts of interest

There are no conflicts to declare.

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